

	Type	L #	Hits	Search Text	DBs
12	BRS	L12	24	L2 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
13	BRS	L17	1	"6307271".PN.	USPAT
14	BRS	L18	1	"6297078".PN.	USPAT
15	BRS	L19	1	"6291898".PN.	USPAT
16	BRS	L20	1	"6215182".PN.	USPAT
17	BRS	L21	1	"6169331".PN.	USPAT
18	BRS	L22	1	"6160313".PN.	USPAT
19	BRS	L23	1	"6148505".PN.	USPAT
20	BRS	L24	1	"6121690".PN.	USPAT
21	BRS	L25	1	"5962926".PN.	USPAT
22	BRS	L26	1	"5801450".PN.	USPAT
23	BRS	L27	1	"5796171".PN.	USPAT
24	BRS	L28	1	"5691568".PN.	USPAT
25	BRS	L29	1	"5468999".PN.	USPAT
26	BRS	L30	1	"5359227".PN.	USPAT
27	BRS	L31	1	"6215182".PN.	USPAT
28	BRS	L32	1	"6005778".PN.	USPAT
29	BRS	L33	1	"5422435".PN.	USPAT
30	BRS	L34	1	"5395038".PN.	USPAT
31	BRS	L35	1	"5386936".PN.	USPAT
32	BRS	L36	1	"5142239".PN.	USPAT
33	BRS	L37	1	"4800393".PN.	USPAT
34	BRS	L13	18	L3 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB

	Type	L #	Hits	Search Text	DBs
35	BRS	L38	1	"5311057".PN.	USPAT
36	BRS	L39	1	"5274270".PN.	USPAT
37	BRS	L40	1	"5134539".PN.	USPAT
38	BRS	L41	1	"5103283".PN.	USPAT
39	BRS	L42	1	"5049979".PN.	USPAT
40	BRS	L43	1	"4994936".PN.	USPAT
41	BRS	L44	1	"4989117".PN.	USPAT
42	BRS	L45	1	"4945399".PN.	USPAT
43	BRS	L14	10	L4 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
44	BRS	L15	49	L5 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
45	BRS	L46	1	"6340846".PN.	USPAT
46	BRS	L47	1	"6262488".PN.	USPAT
47	BRS	L48	1	"6133637".PN.	USPAT
48	BRS	L49	1	"5721452".PN.	USPAT
49	BRS	L50	1	"5177032".PN.	USPAT
50	BRS	L51	1	"5176311".PN.	USPAT
51	BRS	L52	1	"5172215".PN.	USPAT
52	BRS	L53	1	"5040052".PN.	USPAT
53	BRS	L16	51	L6 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
54	BRS	L54	1172	257/686.ccls.	USPAT; US-PGPUB

	Type	L #	Hits	Search Text	DBs
55	BRS	L55	52	L54 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
56	BRS	L56	453	257/784.ccls.	EPO; JPO; IBM TDB
57	BRS	L57	355	257/786.ccls.	EPO; JPO; IBM TDB
58	BRS	L58	449	257/773.ccls.	EPO; JPO; IBM TDB
59	BRS	L59	134	257/777.ccls.	EPO; JPO; IBM TDB
60	BRS	L60	0	L56 and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
61	BRS	L61	0	L56 and wire and bonding adj (pad or finger) and first adj (chip or die)	EPO; JPO
62	BRS	L62	3	(bonding adj wire) and (relay adj pad) and first adj (chip or die)	USPAT; US-PGPUB
63	BRS	L63	1	"6132543".PN.	USPAT
64	BRS	L64	1	"5886876".PN.	USPAT
65	BRS	L65	0	(bonding adj wire) and (relay adj pad) and first adj (chip or die)	EPO; JPO; IBM TDB

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	1771	324/754.ccls.	USPAT	2004/02/24 13:42
2	BRS	L2	265	1 and (probe with ground)	USPAT	2004/02/24 13:40
3	BRS	L3	2	2 and 324/688.ccls.	USPAT	2004/02/24 13:04
4	BRS	L4	22	1 and (probe with (ground adj contact))	USPAT	2004/02/24 13:43
5	BRS	L5	4	("4697143" "4894612" "5351001" "5373231") .pn.	USPAT	2004/02/24 13:34
6	BRS	L6	12	("4791363" "4849689" "5172053" "5506515" "5563522" "5565788" "6023171" "6118287" "6172497" "6191594" "6242930" "6310483") .pn.	USPAT	2004/02/24 13:36
7	BRS	L7	4	("4259635" "4536705" "5933015" "6417682") .pn.	USPAT	2004/02/24 13:38
8	BRS	L8	1	5408188.pn.	USPAT	2004/02/24 13:39
9	BRS	L9	212	324/688.ccls.	USPAT	2004/02/24 13:40
10	BRS	L10	13	9 and (contact near3 ground)	USPAT	2004/02/24 13:40
11	BRS	L11	14	9 and (contact\$3 near3 ground)	USPAT	2004/02/24 13:41
12	BRS	L12	4091	324/755-766.ccls.	USPAT	2004/02/24 13:42
13	BRS	L13	16	12 and (probe with (ground adj contact))	USPAT	2004/02/24 13:43

	Type	L #	Hits	Search Text	DBs	Time Stamp
14	BRS	L14	49	12 and (probe with (ground near2 contact\$3))	USPAT	2004/02/24 13:48
15	BRS	L15	17	(5 6 7 8) and (microwave (high adj frequenc\$3))	USPAT	2004/02/24 13:49

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	2	"L1" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
2	BRS	L2	1140	257/784.ccls.	USPAT; US-PGPUB
3	BRS	L3	1128	257/786.ccls.	USPAT; US-PGPUB
4	BRS	L4	1469	257/773.ccls.	USPAT; US-PGPUB
5	BRS	L5	1015	257/777.ccls.	USPAT; US-PGPUB
6	BRS	L6	1374	257/723.ccls.	USPAT; US-PGPUB
7	BRS	L10	1	"L5" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
8	BRS	L11	1	"L6" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
9	BRS	L7	2	"L2" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
10	BRS	L8	2	"L3" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB
11	BRS	L9	1	"L4" and wire and bonding adj (pad or finger) and first adj (chip or die)	USPAT; US-PGPUB